

14 NON-MUXED OUT

13 MUX SELECT

FEATURES

- **EPIC™** (Enhanced-Performance Implanted **CMOS) Submicron Process**
- Useful for Jumperless Configuration of PC Motherboard
- Inputs Accept Voltages to 5.5 V
- **MUX OUT Signals are 2.5-V Outputs**
- NON-MUXED OUT Signal is a 3.3-V Output
- **Minimum of 1000 Write Cycles**
- Minimum of 10 Years Data Retention
- **Package Options Include Plastic** Small-Outline (D), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages

DESCRIPTION/ORDERING INFORMATION

This 4-bit 1-of-2 multiplexer with I^2C input interface is designed for 3-V to 3.6-V V_{CC} operation.

The PCA8550 is designed to multiplex four bits of data from parallel inputs or from I²C input data stored in a nonvolatile register. An additional bit of register output also is provided, which is latched to prevent changes in the output value during the write cycle. The factory default for the contents of the register is all low. These stored values can be read from, or written to, using the I²C bus. The ability to control writing to the register is provided by the write protect (WP) input. The override (OVERRIDE) input forces all the register outputs to a low.

This device provides a fast-mode (400 kbit/s) or standard-mode (100 kbit/s) I²C serial interface for data input and output. The implementation is as a slave. The device address is specified in the I²C interface definition table. Both of the I²C Schmitt-trigger inputs (SCL and SDA) provide integrated pullup resistors and are 5-V tolerant.

The PCA8550 requires a monotonic power-supply ramp at start-up in the region of 1.1 V to 2.5 V. The nonvolatile registers and I²C state machine initialize to their default states after this V_{CC} level is passed.

The PCA8550 is characterized for operation from 0°C to 70°C.

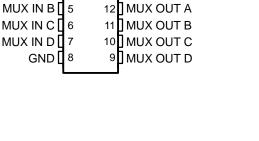
ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
	SOIC – D	Tube of 40	PCA8550D		
0°C to 70°C	30IC - D	Reel of 2500	PCA8550DR		
0°C to 70°C	SSOP – DB	Reel of 2000	PCA8550DBR	PCA8550	
	TSSOP – PW	Reel of 2000	PCA8550PWR	-	

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at (1)www.ti.com/sc/package.



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16 Vcc

15 WP

D, DB, OR PW PACKAGE

(TOP VIEW)

1²C SCL

OVERRIDE 3

MUX IN A 4

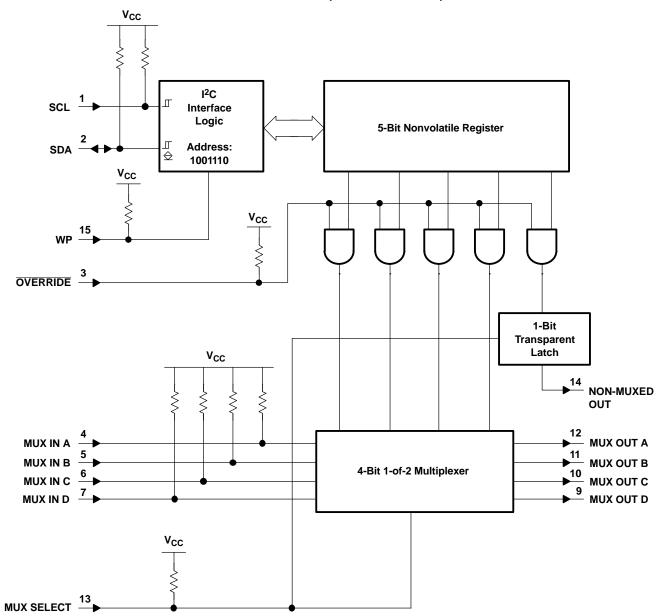
I²C SDA **[**] 2

TEXAS INSTRUMENTS www.ti.com

FUNCTION TABLE

INPL	ITS	OUTPUTS		
MUX SELECT	OVERRIDE	MUX OUT	NON-MUXED OUT	
L	L	L	L	
L	Н	Nonvolatile register	Nonvolatile register	
Н	Х	MUX IN	Latched NON-MUXED OUT ⁽¹⁾	

(1) The latched NON-MUXED OUT state is the value present on the NON-MUXED OUT output at the time the MUX SELECT input transitions from the low to the high state.



LOGIC DIAGRAM (POSITIVE LOGIC)

I²C Interface

 I^2C communication with this device is initiated by a master sending a start condition, a high-to-low transition on the serial data (SDA) input/output while the serial clock (SCL) input is high. After the start condition, the device address byte is sent, MSB first, including the data-direction bit (R/W). This device does not respond to the general call address. After receiving the valid address byte, this device responds with an acknowledge, a low on the SDA input/output during the high of the acknowledge-related clock pulse.

The data byte follows the address acknowledge. If the R/\overline{W} bit is high, the data from this device are the values read from the nonvolatile register. If the R/\overline{W} bit is low, the data are from the master, to be written into the register. A valid data byte is one in which the three high-order bits are low. The first valid data byte that is received is written into the register, following the stop condition. If an invalid data byte is received, it is acknowledged, but is not written into the register. The data byte is followed by an acknowledge sent from this device. If other data bytes are sent from the master, following the acknowledge, they are ignored by this device.

A stop condition, a low-to-high transition on the SDA input/output while the SCL input is high, is sent by the master. If the WP input is low during the falling edge of the first valid data byte acknowledge on the SCL input and the R/\overline{W} bit is low, the stop condition causes the I²C interface logic to write the data byte value into the nonvolatile register. Data are written only if complete bytes are received and acknowledged. Writing to the register takes time (t_{wr}), during which the device does not respond to its slave address. If the WP input is high, the I²C interface logic does not write to the register.

BYTE	BIT									
DTIE	7 (MSB)	6	5	4	3	2	1	0 (LSB)		
Address	Н	L	L	Н	Н	Н	L	R/W		
Data	L	L	L	NON- MUXED OUT	MUX OUT D	MUX OUT C	MUX OUT B	MUX OUT A		

I²C Interface Definition Table

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CC}	Supply voltage range	-0.5	6.5	V	
VI	Input voltage range ⁽²⁾		-0.5	6.5	V
		SDA ⁽²⁾	-0.5	6.5	
Vo	Output voltage range	MUX OUT outputs ⁽²⁾	-0.5	2.9	V
-		NON-MUXED OUT output ⁽²⁾⁽³⁾	-0.5	V _{CC} + 0.5	
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{ОК}	Output clamp current	$V_{\rm O}$ < 0 or $V_{\rm O}$ > $V_{\rm CC}^{(3)}$		-50, +10	mA
I _{IOK}	Input/output clamp current	V ₀ < 0		-50	mA
I _O	Continuous output current	$V_{O} = 0$ to $V_{CC}^{(3)}$		±15	mA
	Continuous current through V_{CC} or GND			±30	mA
		D package		113	
θ_{JA}	Package thermal impedance ⁽⁴⁾	DB package	131		°C/W
		PW package		149	
T _{stg}	Storage temperature range		-65	85	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CC} is provided in the recommended operating conditions table.

(4) The package thermal impedance is calculated in accordance with JESD 51.

PCA8550 NONVOLATILE 5-BIT REGISTER WITH I²C INTERFACE

SCPS050C-MARCH 1999-REVISED MAY 2005



Recommended Operating Conditions

			MIN	MAX	UNIT	
V _{CC}	Supply voltage		3	3.6	V	
V	High-level input voltage	SCL, SDA	2.7	4		
VIH	High-level linput voltage	OVERRIDE, MUX IN, MUX SELECT, WP	2	4	V	
V _{IL} Low-leve		SCL, SDA	-0.5	0.9	V	
	Low-level input voltage	OVERRIDE, MUX IN, MUX SELECT, WP	-0.5	0.8	v	
I _{OH}	High-level output current	MUX OUT, NON-MUXED OUT		-2	mA	
		SDA		6	~ ^	
IOL	Low-level output current	MUX OUT, NON-MUXED OUT		2	mA	
$\Delta t/\Delta v$	Input transition rise or fall rate	OVERRIDE, MUX IN, MUX SELECT, WP		10	ns/V	
T _A	Operating free-air temperature		0	70	°C	

Electrical Characteristics

over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted)

PARAMETER		TEST	MIN	MAX	UNIT	
V _{IK}	Input diode clamp voltage	I _I = -18 mA		-1.5		V
V _{hys} ⁽¹⁾	SCL, SDA			0.19		V
		I _{OH} = −100 μA		2	2.625	
V	MUX OUT	I _{OH} = -1 mA		1.7	2.625	V
V _{OH}	NON-MUXED OUT	I _{OH} = −100 μA		2.4	3.6	v
	NON-MOXED OUT	I _{OH} = -2 mA		2	3.6	1
	MUX OUT	I _{OL} = 100 μA		-0.3	0.4	
	MOX OUT	I _{OL} = 2 mA	-0.3	0.7	V	
V	NON-MUXED OUT	I _{OL} = 100 μA	-0.5	0.4		
V _{OL}	NON-MOXED OUT	I _{OL} = 2 mA	-0.5	0.7		
	SDA	I _{OL} = 3 mA		0.4		
		I _{OL} = 6 mA			0.6	1
	SCL, SDA			-1.5	-12	
I _{IH}	OVERRIDE, MUX SELECT, WP	V _{IH} = 2.4 V	-20	-100	μΑ	
	MUX IN			-0.166	-0.75	mA
	SCL, SDA			-7	-32	۸
I _{IL}	OVERRIDE, MUX SELECT, WP	V _{IL} = 0.4 V		-86	-267	μA
	MUX IN			-0.72	-2	mA
	During read or write cycle	$V_{I} = 0$ to V_{CC} , $I_{O} = 0$	$V_{\rm CC} = 3.3 \ {\rm V}$		10	mA
I _{CC}	Not during read or write cycle	$V_{I} = V_{CC},$ $I_{O} = 0$)		500	μA
Ci		$V_I = V_{CC}$ or GND			10	pF

(1) V_{hys} is the hysteresis of Schmitt-trigger inputs.

Nonvolatile Storage Specifications

PARAMETER	SPECIFICATIONS
Write time (t _{wr})	10 ms, typical
Memory-cell data retention	10 years, minimum
Maximum number of memory-cell write cycles	1000 cycles, minimum



I²C Interface Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

		V_{CC} = 3.3 V \pm	0.3 V	UNIT
		MIN	MAX	UNIT
f _{scl}	I ² C clock frequency	10	400	kHz
t _{sch}	I ² C clock high time	600		ns
t _{scl}	I ² C clock low time	1.3		μs
t _{sp}	I ² C spike time	0	50	ns
t _{sds}	I ² C serial data setup time	100		ns
t _{sdh}	I ² C serial data hold time	0	900	ns
t _{icr}	I ² C input rise time	20	300	ns
t _{icf}	I ² C input fall time	20	300	ns
t _{ocf}	I ² C output fall time (10-pF to 400-pF bus)	20 + 0.1 C _b ⁽¹⁾	250	ns
t _{buf}	I ² C bus free time between stop and start	1.3		μs
t _{sts}	I ² C start or repeated start condition setup	600		ns
t _{sth}	I ² C start or repeated start condition hold	600		ns
t _{sps}	I ² C stop condition setup	600		ns
C _b ⁽¹⁾	I ² C bus capacitive load		400	pF

(1) C_b = capacitance of one bus line in pF

Switching Characteristics

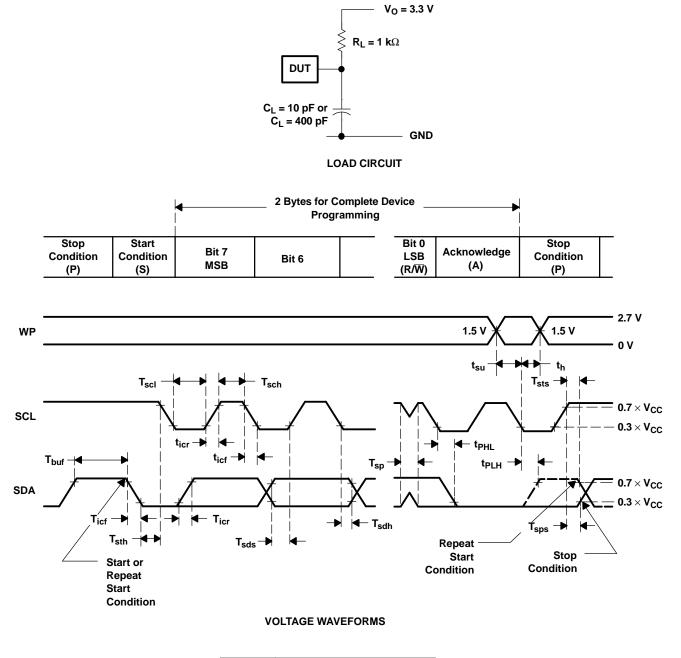
over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

PARAMETER			FROM TO (INPUT) (OUTPUT)		V _{CC} = 3.3 V ± 0.3 V	
		(INFOT)	(001-01)	MIN	MAX	
t _{mpd}	Mux input to output propagation delay	MUX IN	MUX OUT		20	ns
t _{sov}	MUX SELECT to output valid	MUX SELECT	Output valid		22	ns
t _{ovn}	OVERRIDE to NON-MUXED OUT output delay	OVERRIDE	NON-MUXED OUT		15	ns
t _{ovm}	OVERRIDE to MUX OUT output delay	OVERRIDE	MUX OUT		25	ns
t _{su}	Setup time	WP	Falling edge of first valid data byte acknowledge on the SCL input	30		ns
t _h	Hold time	WP	Falling edge of first valid data byte acknowledge on the SCL input	120		ns
t _r	Output rise time			1	3	ns/V
t _f	Output fall time	1	3	ns/V		

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PARAMETER MEASUREMENT INFORMATION



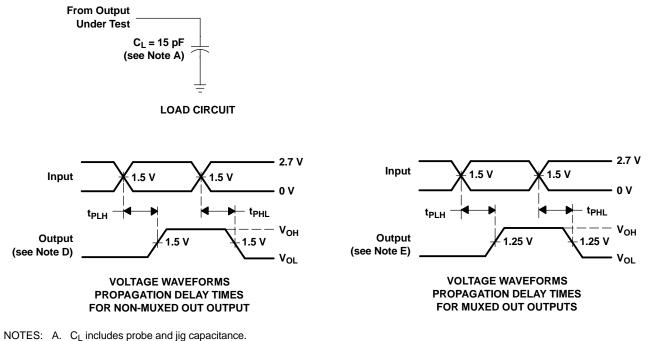
BYTE	DESCRIPTION			
1	I ² C address			
2	Nonvolatile register data			

Figure 1. I²C Interface Load Circuit and Voltage Waveforms

PCA8550 NONVOLATILE 5-BIT REGISTER WITH I²C INTERFACE

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PARAMETER MEASUREMENT INFORMATION



- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r \leq 2.5 ns, t_f \leq 2.5 ns.
 - C. The outputs are measured one at a time, with one transition per measurement.
 - D. t_{PLH} and t_{PHL} are the same as t_{sov} and t_{ovn} .
 - E. t_{PLH} and t_{PHL} are the same as t_{mpd} , t_{sov} , and t_{ovm} .

Figure 2. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
PCA8550D	ACTIVE	SOIC	D	16	TBD	Call TI	Call TI
PCA8550DBR	ACTIVE	SSOP	DB	16	TBD	Call TI	Call TI
PCA8550DBRE4	ACTIVE	SSOP	DB	16	TBD	Call TI	Call TI
PCA8550DE4	ACTIVE	SOIC	D	16	TBD	Call TI	Call TI
PCA8550DR	ACTIVE	SOIC	D	16	TBD	Call TI	Call TI
PCA8550DRE4	ACTIVE	SOIC	D	16	TBD	Call TI	Call TI
PCA8550PWR	ACTIVE	TSSOP	PW	16	TBD	Call TI	Call TI
PCA8550PWRE4	ACTIVE	TSSOP	PW	16	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AC.



MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



MECHANICAL DATA

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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